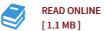




Multi-layer printed circuit board production process [Paperback](Chinese Edition)

By BEN SHE.YI MING

paperback. Book Condition: New. Paperback Pages Number: 145 Language: Simplified Chinese Publisher: Publishing House of Electronics Industry; 1 edition (September 1. 2011). Multi-layer printed circuit board production process involved in electronics. mechanical engineering. fluid mechanics. thermodynamics. chemistry. physics. metallurgy and optical expertise in the field. covering the whole process of printed circuit boards production. it includes not only the manufacture. assembly and testing of printed circuit boards. and.



Reviews

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